

### **Description**

AM3109 is a miniature digitally tunable highpass filter covering the 18.0 to 26.5 GHz frequency range. The filter provides 32 selectable highpass cutoff states with 5 digital control bits. The tunable lowpass filter can be combined with one of Atlanta Micro's tunable lowpass filters to provide a flexible tunable bandpass filter solution. AM3109 has internal  $50\Omega$ 

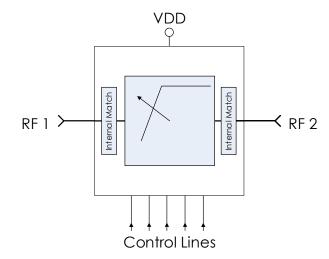


matching, is packaged in a 4mm QFN package, and operates over the -40C to +85C temperature range.

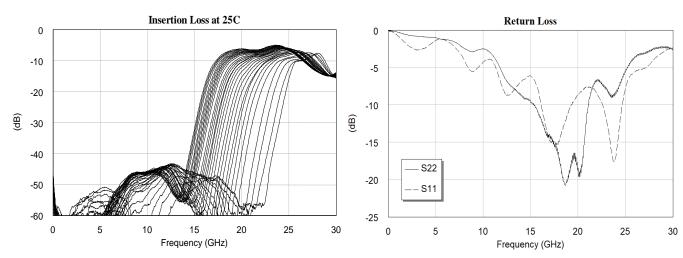
#### **Features**

- Discrete High Pass Cutoff Steps
- 5-bit Control, 3V or 5V Logic
- +3.3V to +5V DC Supply
- 7.0 dB AVG Insertion Loss
- +36 dBm Input IP3
- 4mm QFN Package
- -40C to +85C Operation
- No Calibration Required

### **Functional Diagram**



#### **Characteristic Performance**



# AM3109 – Filter Bank



# Digitally Tunable 18.0 to 26.5 GHz Highpass

### **Table of Contents**

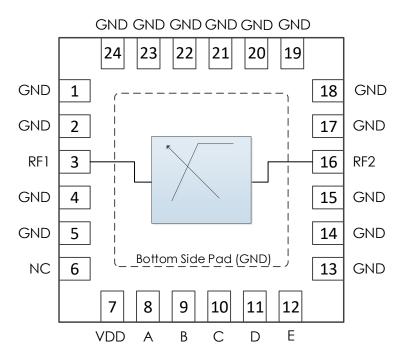
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# **Revision History**

Date	<b>Revision Number</b>	Notes
August 24, 2018	1	Initial Release



## **Pin Layout and Definitions**



Pin Number	Pin Name	Pin Function
1,2	GND	Ground – Common
3	RF1	RF Port 1 – 50 ohms – DC coupled. External DC blocking capacitor required*
4,5	GND	Ground - Common
6	NC	Do Not Connect
7	VDD	DC Power Input
8	Α	Control Bit A
9	В	Control Bit B
10	С	Control Bit C
11	D	Control Bit D
12	Е	Control Bit E
13-15	GND	Ground - Common
16	RF2	RF Port 2 – 50 ohms – DC coupled. External DC blocking
		capacitor required*
17-24	GND	Ground – Common
Case GND	GND	Ground – Common

<sup>\*</sup>Note: DC blocking caps not required if in series with other Atlanta Micro parts of the same reference voltage.



## **Specifications**

#### **Absolute Maximum Ratings**

	Minimum	Maximum
Supply Voltage	-0.3 V	+6.0 V
RF Input Power		+27 dBm
Operating Junction Temperature	-40 C	+150 C
Storage Temperature Range	-50 C	+150 C

**Note:** Any device operation beyond the Absolute Maximum Ratings may result in permanent damage to the device. The values listed in this table are extremes and do not imply functional operation of the device at these or any other conditions beyond what is listed under Recommended Operating Conditions. Any part subjected to conditions outside of what is recommended for an extended amount of time may suffer from reliability concerns.

#### **Handling Information**

	Minimum	Maximum
Storage Temperature Range (Recommended)	-50 C	+125 C
Moisture Sensitivity Level	MSL 1	



Atlanta Micro products are electrostatic sensitive. Follow safe handling practices to avoid damage

### **Recommended Operating Conditions**

	Minimum	Typical	Maximum
Supply Voltage	+2.7 V	+5.0 V	
Operating Case Temperature	-40 C		+85 C
Operating Junction Temperature	-40 C		+125 C

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#### **DC Electrical Characteristics**

(T = 25 °C unless otherwise specified)

Parameter	<b>Testing Conditions</b>	Minimum	Typical	Maximum
DC Supply Voltage		+2.7 V	+5.0 V	
DC Supply Current	VDD = +3.3 V	1 mA		2 mA
	VDD = +5.0 V	1 mA		3 mA
Power Dissipated	VDD = +3.3 V	3.3 mW		6.6 mW
	VDD = +5.0 V	5 mW		15 mW
Logic Level Low		-0.1 V		+0.5 V
Logic Level High		+2.0 V		+VDD

#### **RF Performance**

(T = 25 °C unless otherwise specified)

Parameter	Testing Conditions	Minimum	Typical	Maximum
Frequency Range		18.0 GHz		26.5 GHz
Insertion Loss	f=18 GHz, ABCDE = 00000		7.8 dB	
	f=25 GHz, ABCDE = 00000		6.5 dB	
	f=32 GHz, ABCDE = 00000		7.5 dB	
Return Loss	f=18 GHz, ABCDE = 00000		15.0 dB	
	f=25 GHz, ABCDE = 00000		7.8 dB	
	f=32 GHz, ABCDE = 00000		7.8 dB	
Input IP3	ABCDE = 00000		+36 dBm	

### **Timing Characteristics**

Parameter	Minimum	Typical	Maximum
Switching Speed		1 µs	

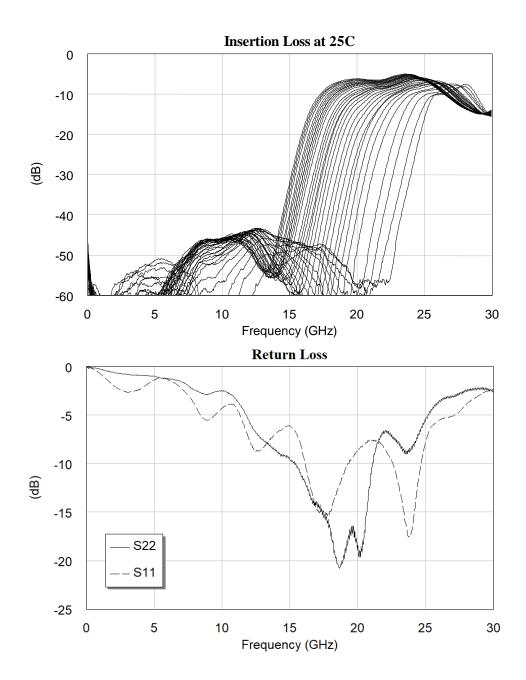


#### **State Table**

Control Lines					Typical Cutoff
E	D	С	В	Α	Frequency (GHz)
L	L	L	L	L	17.91
L	L	L	L	Н	18.02
L	L	L	Н	L	18.16
L	L	L	Н	Н	18.36
L	L	Н	L	L	18.50
L	L	Н	L	Н	18.79
L	L	Н	Н	L	18.99
L	L	Н	Н	Н	19.25
L	Н	L	L	L	19.42
L	Н	L	L	Н	19.60
L	Н	L	Н	L	19.74
L	Н	L	Н	Н	20.01
L	Н	Н	L	L	20.45
L	Н	Н	L	Н	20.68
L	Н	Н	Н	L	20.93
L	Н	Н	Н	Н	21.22
Н	L	L	L	L	21.38
Н	L	L	L	Н	21.67
Н	L	L	Н	L	21.77
Н	L	L	Н	Н	22.05
Н	L	Н	L	L	22.57
Н	L	Н	L	Н	22.84
Н	L	Н	Н	L	22.95
Н	L	Н	Н	Н	23.40
Н	Н	L	L	L	23.59
Н	Н	L	L	Н	24.02
Н	Н	L	Н	L	24.25
Н	Н	L	Н	Н	24.43
Н	Н	Н	L	L	25.29
Н	Н	Н	L	Н	25.43
Н	Н	Н	Н	L	25.90
Н	Н	Н	Н	Н	26.02

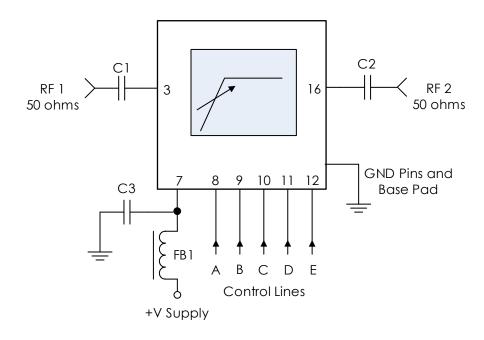


### **Typical Performance**





## **Typical Application**



### Recommended Component List (or equivalent):

Part	Value	Part Number	Manufacturer
C1, C2	0.1 μF	0201BB104KW160	Passives Plus
C3	0.1 μF	C1005X7R1H104K050BB	TDK
FB1	-	MMZ1005A222E	TDK

#### Notes:

- 1. RF blocking capacitors should be high performance, low-loss, broadband capacitors for optimum performance.
- 2. RC filtering on the control lines is recommended to prevent digital noise from coupling to the RF path.
  - a. Select control line RC filter values based on desired logic source decoupling and switching speed.



Pin 1

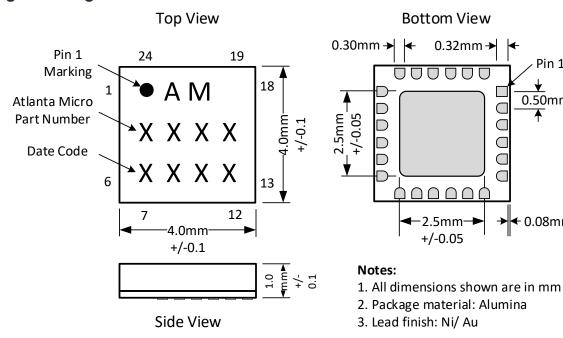
0.50mm

€ 0.08mm

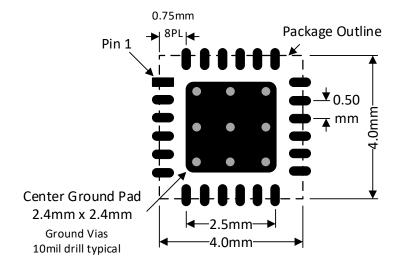
## Digitally Tunable 18.0 to 26.5 GHz Highpass

### **Package Details**

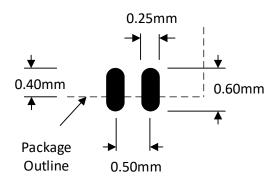
#### **Package Drawing**



### **Recommended Footprint**



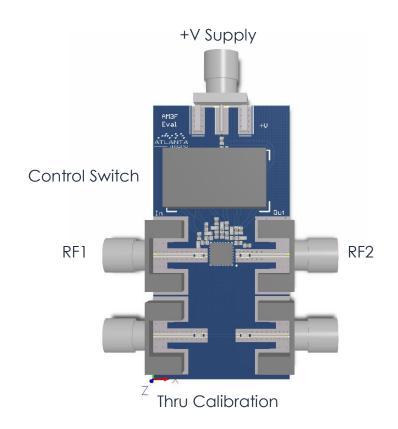
#### **Pad and Spacing Detail**



Recommend 0.08mm soldermask oversize beyond pad outlines



# **Evaluation PC Board**



### **Related Parts**

Part Number				Description
AM3030	3.5 GHz	to	6.5 GHz	Digitally Tunable Lowpass
AM3039	9 GHz	to	18 GHz	Digitally Tunable Lowpass
AM3107	6 GHz	to	12 GHz	Digitally Tunable Lowpass
AM3110	18 GHz	to	26.5 GHz	Digitally Tunable Lowpass
AM3032	2.5 GHz	to	4.5 GHz	Digitally Tunable Highpass
AM3041	6 GHz	to	10 GHz	Digitally Tunable Highpass
AM3108	12 GHz	to	18.0 GHz	Digitally Tunable Highpass



### **Component Compliance Information**

**RoHS:** Atlanta Micro, Inc. hereby certifies that all products comply with the EC Directive 2011/65/EC on the Restriction of Hazardous Substances, commonly known as RoHS II. All products supplied by Atlanta Micro shall be compliant with the European Directive 2011/65/EC based on the following substance list.

Substance List	Allowable Maximum Concentration
Lead (Pb)	<1000 PPM (0.1% by weight)
Mercury (Hg)	<1000 PPM (0.1% by weight)
Cadmium (Cd)	<75 PPM (0.0075% by weight)
Hexavalent Chromium (CrVI)	<1000 PPM (0.1% by weight)
Polybrominated Biphenyls (PBB)	<1000 PPM (0.1% by weight)
Polybrominated Diphenyl ethers (PBDE)	<1000 PPM (0.1% by weight)
Decabromodiphenyl Deca BDE	<1000 PPM (0.1% by weight)

**REACH:** Atlanta Micro, Inc. neither uses nor intentionally adds any of the substances considered to be a Substance of Very High Concern (SVHC) as defined by the EU Regulation (EC) No. 1907-2006 on Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH).

**Conflict Materials:** Atlanta Micro does not knowingly use materials that are sourced from the Democratic Republic of Congo (DRC) or any other known conflict regions. Atlanta Micro's supply chain is comprised of sources that are both environmentally and socially responsible. We periodically review this requirement with our vendors to ensure continued compliance.

Atlanta Micro takes its responsibility as a global partner seriously and will use due diligence within our supply chain to ensure all standards are met to the best of our knowledge.